ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® Internation	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.											
	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater						ials and Mi	als and Mfg Information				
Supplier Information																
Company name*	Company un	Company unique ID			Unique ID Authority					Respons	Response Date*					
nsemi												2025-07-17				
Contact Name	Title - Conta	Title - Contact			Phone - Contact*					Email -	Email - Contact*					
Product-Env-Stewards		Product Env	Product Enviro Compliance			NA					Product-Env-Stewards@onsemi.com					
uthorized Representative*	Title - Repre	Title - Representative			Phone - Representative*				Email - Representative*							
Product-Env-Stewards	Product Env	Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com							
Requester Item Nun	Requester Item Number     Mfr Item Number       FDMC6679AZ					Effective Date     Version     Manufacturing Site       2025-07-17     TH2		uring Site	Weight* 25.5362		* U	JOM	Unit Type			
											n	ng	Each			
Aanufacturing Proccess	Information		1												1	
Terminal Plating / Gr	Terminal Plating / Grid Array Material		se Alloy J-STD-020 MS		L Rating	Peak Process E		Body Temperature Max Time at Pea		Time at Peak	Temperature Number		umber of F	mber of Reflow Cycles		
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		CU Alloy	CU Alloy 1			260		С	30		second	seconds 3				
omments																
vel 1 - maximum time at peal	k temperature during	soldering is 10-3	0 seconds													
or more information regarding	ng material compositi	on please refer to	page 3													

RoHS Material Composition Declaration				Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of							
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all							
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the							
Supplier Digital Signature Ra	stislav Drska	Le										

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.055	mg	Supplier	Silicon (Si)	7440-21-3		1.055	mg
Die Attach	0.1359	mg	Supplier	Silver (Ag)	7440-22-4		0.1155	mg
			Supplier	Acrylic resins	Proprietary Data		0.0204	mg
Lead Frame	13.2	mg	Supplier	Zinc (Zn)	7440-66-6		0.0158	mg
			Supplier	Iron (Fe)	7439-89-6		0.3102	mg
			Supplier	Copper (Cu)	7440-50-8		12.87	mg
			Supplier	Phosphorus (P)	7723-14-0		0.004	mg
Mold Compound-Black	10.3333	mg	Supplier	Silica Amorphous (SiO2)	7631-86-9		0.775	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0517	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		8.215	mg
			Supplier	EpoxyNovolaCresins (Cresolic)	64425-89-4		0.5167	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.775	mg
Plating	0.259	mg	Supplier	Palladium (Pd)	7440-05-3		0.0185	mg
			В	Nickel (Ni)	7440-02-0		0.2375	mg
			Supplier	Gold (Au)	7440-57-5		0.0031	mg
Wire Bond	0.553	mg	Supplier	Palladium (Pd)	7440-05-3		0.0072	mg
			Supplier	Copper (Cu)	7440-50-8		0.5458	mg

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).